

SECU1401C-S

● External Shape Type : 3.0 × 1.5 Surface Mount LED (Flat Lens Type)

Color : GreenLens color : Clear

Material of a chip: AlGaInP

● Application: Automotive, Consumer Electronics, Office Automation, Indicator

• Feature: High Luminous Intensity, RoHS compliant,

Compatible with heat-resistance of lead-free solder.

Rating

| Description | Symbol | Ratings | Unit | Remark | |
|---------------------------|--------|-----------------|-------|----------------------|--|
| Forward current | IF | 30 | mA | | |
| Forward current reduction | ⊿IF | -0.45 | mA/°C | Avobe25°C | |
| Pulse forward current | IFP | 100 | mA | f=1kHz tw≦100 μ s | |
| Reverse voltage | VR | 5 | V | | |
| Operating temperature | Topr | −30 ~ 85 | °C | | |
| Storage temperature | Tstg | −30~100 | °C | | |

● Photoelectric characteristic (Ta=25°C)

| Description | Symbol | Conditions | Min | Тур | Max | Unit |
|---------------------|---------------|------------|-----|-----|-----|------|
| Forward voltage | VF | IF = 20mA | | 2.1 | 2.5 | V |
| Reverse current | IR | VR = 5V | | | 10 | μΑ |
| Luminous intensity | IV | IF = 20mA | 10 | 13 | | mcd |
| Peak wavelength | λp | IF = 20mA | | 562 | | nm |
| Dominant wavelength | λ d | IF = 20mA | | 562 | | nm |
| Spectral bandwidth | ⊿λ | IF = 20mA | | 12 | | nm |
| Directional angle | $2\theta 1/2$ | IF = 20mA | | _ | | deg. |

● Luminous intensity rank (Ta=25°C)

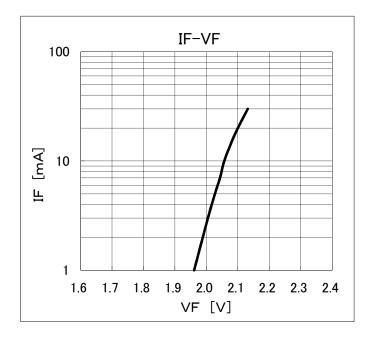
| rank | Luminous intensity range(mcd) | | |
|------|-------------------------------|---|----|
| С | 10 | ~ | 19 |
| D | 13 | ~ | |

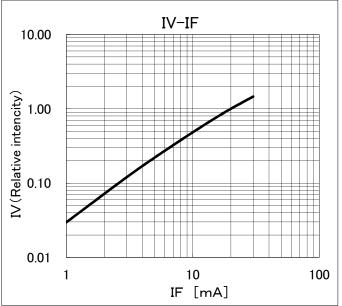
●Dominant wavelength rank (Ta=25°C) Tolerance: ±2nm

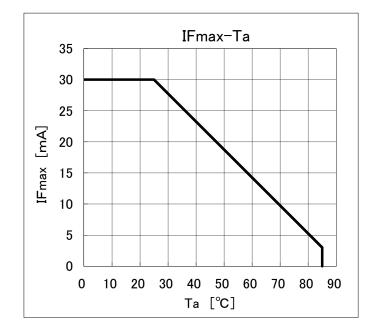
| rank | Dominant Wavelengs range(nm) | | |
|------|---------------------------------|---|-------|
| G2 | 560.0 | ~ | 561.0 |
| G1 | 561.0 | ~ | 562.5 |
| Υ | 562.5 | ~ | 565.0 |

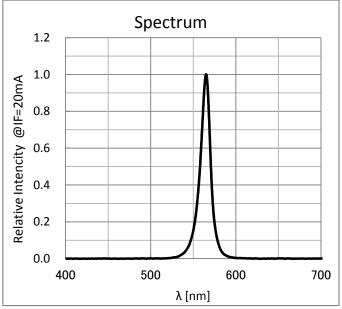


Characteristic data

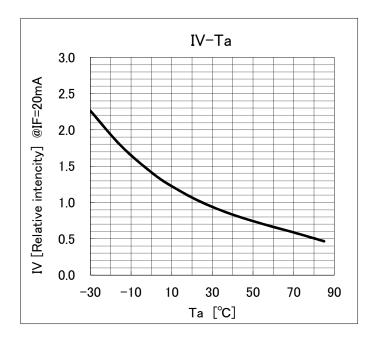


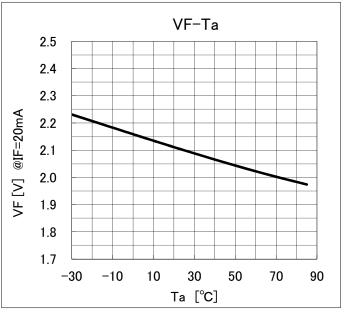








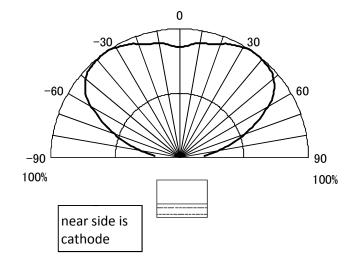




Directional angle: X direction

-90 100% Cathode

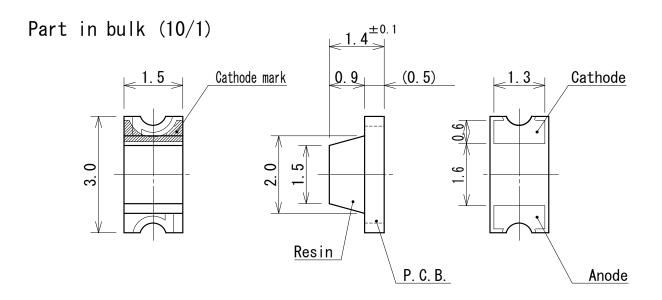
Directional angle: Y direction



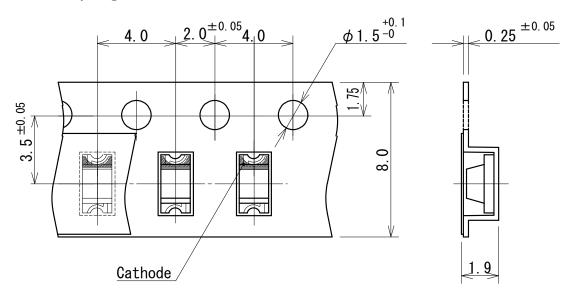


Outline

SEC1001 Series Outline dimensions



Embossed taping (5/1)



Material of leads: Copper

Finish: Au plating

Material of resin: Epoxy

Tolerance ± 0.2



Soldering conditions

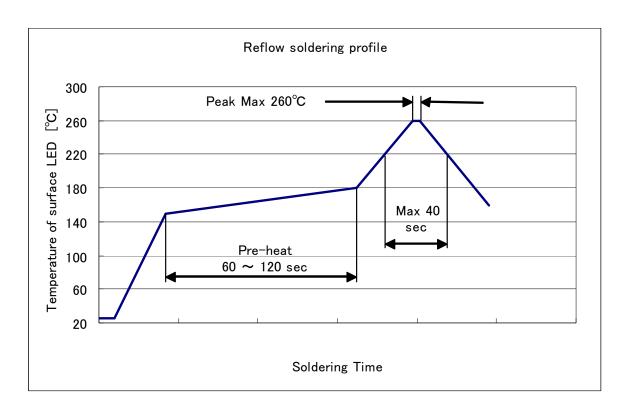
Following soldering conditions are recommended.

1 Reflow conditions (at the surface of LED resin)

Pre-heat :150 \sim 180 °C, 60 \sim 120 sec

Soldering temperature: Soldering time more than 220°C is less than 40 sec.

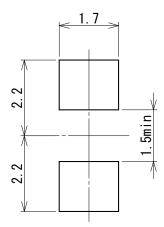
Peak temperature is should be is less than 260°C.



2 Manual soldering

Temperature of soldering iron tip should be $350\pm10^{\circ}$ C for 3 seconds, which shall apply to only one soldered point and once for the each soldered point.

3 Recommendable soldering pattern



Unit:mm

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Attention after opened

The LED is in SMD package. When the LED is mounted by means of soldering and the resin is unusually damp, soldering may cause interfacial defoliation.

This occurs when a drastic temperature change causes moisture in the resin to evaporate and to swell. Therefore, attention to the below must be paid.

① Atmosphere when using the LEDs after package is opened
After opened and mounted, soldering should be carried out quickly.
Following atmosphere is recommended when using (and mounting) the LEDs.

Temperature : 5~30°C Humidity : less than 70%

2 Baking

In case 48 hours have passed after package is opened, LEDs must be dried as follows.

60±5 °C for more than 24 hours (taping reel)

3 Storage after package is opened

Following storage conditions are recommended after package is opened.

In case indicator color (blue) of desiccant (ex. silica gel) has disappeared. LEDs must be dried under the same conditions as ② above.

Other

- ① After soldering any mechanical force or excessive vibration should not be applied to LEDs during cooling process until the LEDs cool down to normal temperature.
- 2 Quick cooling must be avoided.
- 3 The LEDs should not be mounted on warped direction of PCB.



Reliability test

| | Test Items | EIAJ ED-4701 | Test Conditions |
|------------------|-----------------------------|--------------|---|
| Life Tests | Steady state operating life | - | Ta=RT、Ifmax t=1000h |
| | High temperature storage | 201 | Ta=Tstgmax t=1000h |
| Environ | Low temperature storage | 202 | Ta=Tstgmin t=1000h |
| -mental Tests | Moisture Resistance | 103 | Ta=60±5°C、RH=90±5% t=1000h |
| | Temperature cycle | 105 | Tstgmin(30min)~Tstgmax(30min) 100cycles |
| | Soldering heat | 301 | T=260±5°C, t=10s, 1time |
| | Solderaibirity | 402 | T=245±5°C, t=5±1s, 1time, Using flux for Pb free solder |
| | Drop | - | H=1m, Drop on maple board, 10times |

Mesurement Item and Criterion Judge Failure

| No | Measurement Item | Mark | Criterion Judge Failure |
|----|--------------------|------|-------------------------|
| 1 | Forward Voltage | VF | OK≦V.F.S.×±20% |
| 2 | Reverse Current | IR | OK≦U.S.L×2.0 |
| 3 | Luminous Intensity | Iv | OK≧I.V.S.×0.5 |

^{*}Solderability ... The Lead shall be covered by solder at least 95%.

Mesurement conditions is based on specifications.

Tstgmax and Tstgmin is absolute maximum ratings.

IFmax and IFPmax is absolute maximum ratings.

U.S.L. is upper limit of standard.

V.F.S. is Initial data of VF.

I.V.S. is Initial data of Luminous Intensity.

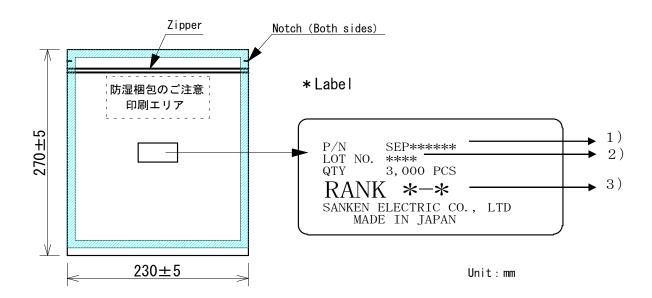


Packing

Packing Material: Aluminum laminated moisture-proof packing

Quantity: 3000 pcs (Minimum order quantity)

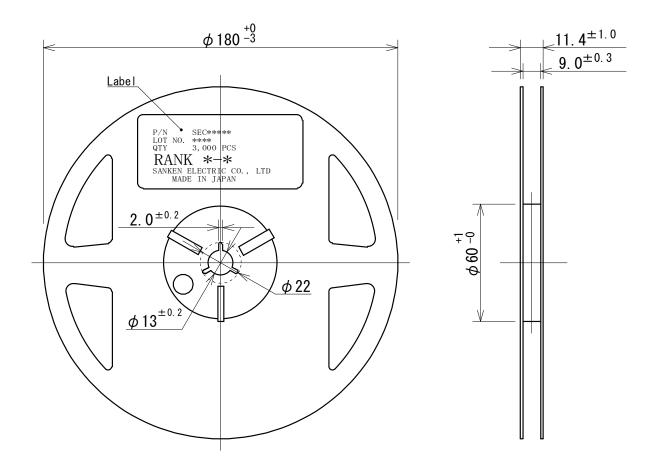
Label: See below.



- 1) Part Number : SEC * * * * *
- 2) Lot No. : * * * ** ↑ ↑ ↑ ① ② ③
- 1 Last digit of year.
- 2 Month
- (January~September→Arabic Numeral
- October \rightarrow O, November \rightarrow N, December \rightarrow D)
- 3Day
- 3) quantity : 3000pcs
- 4) Rank : * *
 ↑ ↑
 ① ②
 - ①Luminous intensity rank
 - 2 Dominant wavelength rank



Taping reel dimensions



Tolerance ± 0.2

①Quantity

The quantity per reel shall be 3000 pcs.

②Accumulative pitch tolerance

Accumulative tolerance per 10 pitches shall be ± 0.2 mm.

3Adhesion strength of cover tape

Adhesion strength shall be 0.1-0.7N when the cover tape and the carrier tape are torn off at the angle of 10 degrees.

4 Packaging

P/N, manufacturing date code number and quantity shall be indicated on a moist-proof package.

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Tips

- •The contents written in this data sheet may be changed without a preliminary announcement by improvement etc.

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